

# 2SC3512

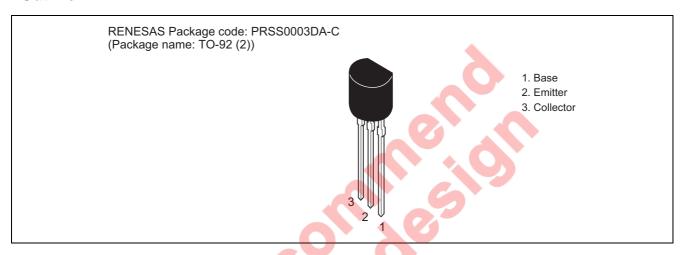
## Silicon NPN Epitaxial

REJ03G0714-0300 Rev.3.00 Apr 20, 2006

## **Application**

UHF / VHF wide band amplifier

### **Outline**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	15	V
Collector to emitter voltage	V <sub>CEO</sub>	11	V
Emitter to base voltage	$V_{EBO}$	2	V
Collector current	Ic	50	mA
Collector power dissipation	P <sub>C</sub>	600	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

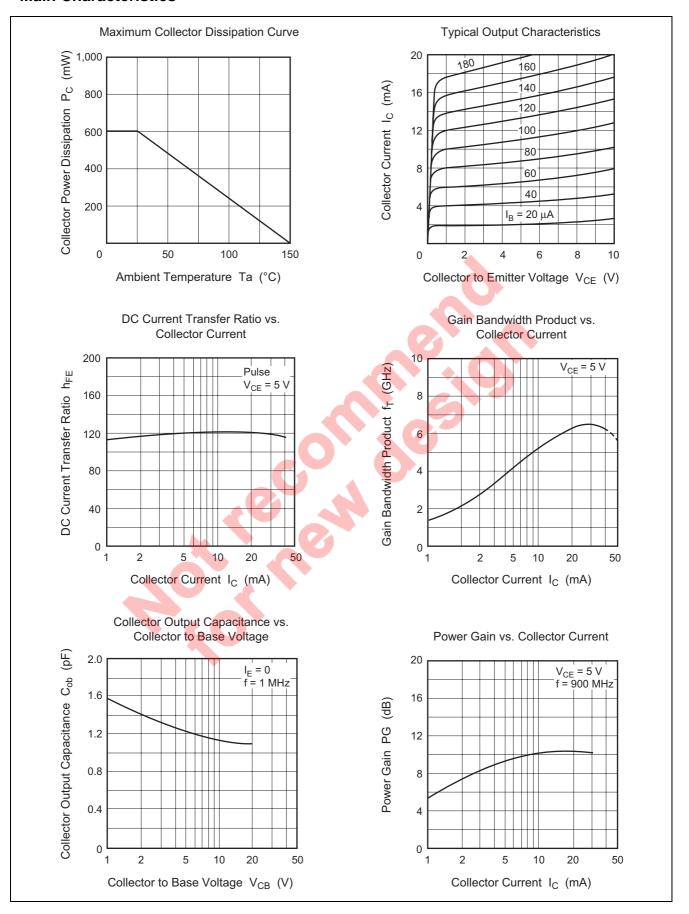
### **Electrical Characteristics**

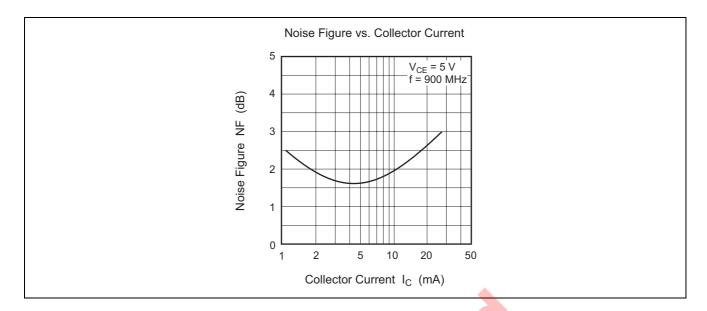
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to cutoff current	I <sub>CEO</sub>	_	_	1	μΑ	V <sub>CE</sub> = 10 V, R <sub>BE</sub> = ∞
Emitter cutoff current	I <sub>EBO</sub>	_	_	1	μΑ	$V_{EB} = 1 \text{ V}, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	1	μΑ	$V_{CB} = 12 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE</sub>	50	120	250		$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Collector output capacitance	Cob	_	1.2	1.6	pF	$V_{CB} = 5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f⊤	_	6.0	_	GHz	$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Power gain	PG	_	10.5	_		$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA},$ f = 900 MHz
Noise figure	NF	_	1.6	_		V <sub>CE</sub> = 5 V, I <sub>C</sub> = 5 mA, f = 900 MHz



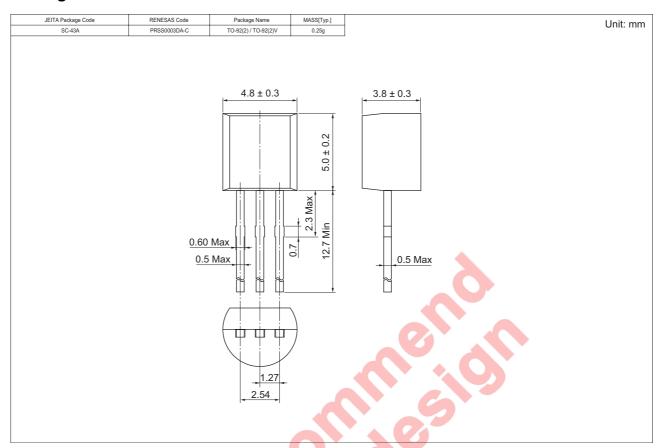
### **Main Characteristics**







## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity		Shipping Container
2SC3512TZ-E	2500	Hol	d Box, Radial Taping

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